

## SN74AHC1G00 单路 2 输入正与非门

### 1 特性

- 工作电压范围：2V 至 5.5V
- 5V 时  $t_{pd}$  最大值为 6.5ns
- 低功耗：最大  $I_{CC}$  为 10 $\mu$ A
- 5V 下的输出驱动为  $\pm 8$ mA
- 所有输入端均采用施密特触发器，使得电路能够承受较慢的输入上升和下降时间
- 闩锁性能超过 250mA，符合 JESD 17 规范

### 2 应用

- 启用或禁用数字信号
- 控制指示灯 LED
- 通信模块和系统控制器之间的转换

### 3 说明

SN74AHC1G00 以正逻辑执行布尔函数  
 $Y = \overline{A \cdot B}$  或  $Y = \overline{A} + \overline{B}$ 。

#### 封装信息

| 器件型号        | 封装 <sup>(1)</sup>  | 封装尺寸 <sup>(2)</sup> | 封装尺寸 <sup>(2)</sup> |
|-------------|--------------------|---------------------|---------------------|
| SN74AHC1G00 | DBV ( SOT-23 , 5 ) | 2.9mm x 2.8mm       | 2.9mm x 1.6mm       |
|             | DCK ( SC-70 , 5 )  | 2mm x 2.1mm         | 2mm x 1.25mm        |
|             | DRL (SOT, 5)       | 1.6mm x 1.6mm       | 1.6mm x 1.2mm       |

- (1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。
- (2) 封装尺寸 ( 长 × 宽 ) 为标称值，并包括引脚 ( 如适用 )。



逻辑图 ( 正逻辑 )



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## 4 Pin Configuration and Functions

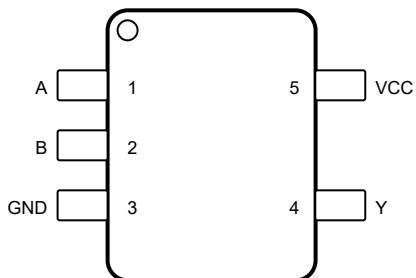


图 4-1. DBV Package 5-Pin SOT-23 Top View

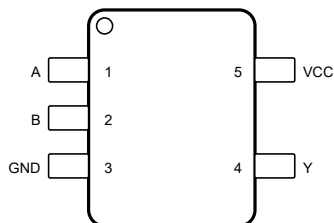


图 4-2. DCK Package 5-Pin SC70 Top View

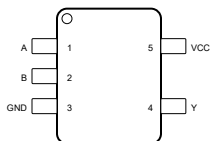


图 4-3. DRL Package 5-Pin SOT Top View

表 4-1. Pin Functions

| PIN |                 | TYPE <sup>(1)</sup> | DESCRIPTION |
|-----|-----------------|---------------------|-------------|
| NO. | NAME            |                     |             |
| 1   | A               | I                   | A input     |
| 2   | B               | I                   | B input     |
| 3   | GND             | —                   | Ground      |
| 4   | Y               | O                   | Output      |
| 5   | V <sub>CC</sub> | —                   | Power       |

(1) Signal Types: I = Input, O = Output, I/O = Input or Output

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                      |                                            | MIN                                  | MAX            | UNIT   |
|----------------------|--------------------------------------------|--------------------------------------|----------------|--------|
| $V_{CC}$             | Supply voltage                             | −0.5                                 | 7              | V      |
| $V_I$ <sup>(2)</sup> | Input voltage                              | −0.5                                 | 7              | V      |
| $V_O$ <sup>(2)</sup> | Output voltage                             | −0.5                                 | $V_{CC} + 0.5$ | V      |
| $I_{IK}$             | Input clamp current                        | $(V_I < 0)$                          |                | −20 mA |
| $I_{OK}$             | Output clamp current                       | $(V_O < 0 \text{ or } V_O > V_{CC})$ |                | ±20 mA |
| $I_O$                | Continuous output current                  | $(V_O = 0 \text{ to } V_{CC})$       |                | ±25 mA |
|                      | Continuous current through $V_{CC}$ or GND |                                      |                | ±50 mA |
| $T_J$                | Maximum junction temperature               |                                      |                | 150 °C |
| $T_{stg}$            | Storage temperature                        | −65                                  | 150            | °C     |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 5.2 ESD Ratings

|             |                         | VALUE                                                                          | UNIT  |
|-------------|-------------------------|--------------------------------------------------------------------------------|-------|
| $V_{(ESD)}$ | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 |
|             |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                     |                                    | MIN                                        | MAX      | UNIT |
|---------------------|------------------------------------|--------------------------------------------|----------|------|
| $V_{CC}$            | Supply voltage                     | 2                                          | 5.5      | V    |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 2 \text{ V}$                     | 1.5      | V    |
|                     |                                    | $V_{CC} = 3 \text{ V}$                     | 2.1      |      |
|                     |                                    | $V_{CC} = 5.5 \text{ V}$                   | 3.85     |      |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 2 \text{ V}$                     | 0.5      | V    |
|                     |                                    | $V_{CC} = 3 \text{ V}$                     | 0.9      |      |
|                     |                                    | $V_{CC} = 5.5 \text{ V}$                   | 1.65     |      |
| $V_I$               | Input voltage                      | 0                                          | 5.5      | V    |
| $V_O$               | Output voltage                     | 0                                          | $V_{CC}$ | V    |
| $I_{OH}$            | High-level output current          | $V_{CC} = 2 \text{ V}$                     | −50      | μA   |
|                     |                                    | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | −4       | mA   |
|                     |                                    | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$   | −8       |      |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 2 \text{ V}$                     | 50       | μA   |
|                     |                                    | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 4        | mA   |
|                     |                                    | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$   | 8        |      |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 100      | ns/V |
|                     |                                    | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$   | 20       |      |

## 5.3 Recommended Operating Conditions (续)

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                |                                | MIN | MAX | UNIT |
|----------------|--------------------------------|-----|-----|------|
| T <sub>A</sub> | Operating free-air temperature | −40 | 125 | °C   |

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, [SCBA004](#).

## 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | SN74AHC1G00  |            |           | UNIT |
|-------------------------------|----------------------------------------------|--------------|------------|-----------|------|
|                               |                                              | DBV (SOT-23) | DCK (SC70) | DRL (SOT) |      |
|                               |                                              | 5 PINS       | 5 PINS     | 5 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 278          | 289.2      | 256       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 180.5        | 205.8      | 130       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 184.4        | 176.2      | 152       | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 115.4        | 117.6      | 9.9       | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 183.4        | 175.1      | 152       | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bot) thermal resistance    | N/A          | N/A        | N/A       | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 5.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER <sup>(1)</sup>                  | TEST CONDITIONS          |                                  | V <sub>CC</sub> | MIN  | TYP | MAX | UNIT |
|-------------------------------------------|--------------------------|----------------------------------|-----------------|------|-----|-----|------|
| V <sub>OH</sub> High level output voltage | I <sub>OH</sub> = −50 μA | T <sub>A</sub> = 25°C            | 2 V             | 1.9  | 2   |     | V    |
|                                           |                          | T <sub>A</sub> = −40°C to +85°C  |                 | 1.9  |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +125°C |                 | 1.9  |     |     |      |
|                                           |                          | T <sub>A</sub> = 25°C            | 3 V             | 2.9  | 3   |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +85°C  |                 | 2.9  |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +125°C |                 | 2.9  |     |     |      |
|                                           |                          | T <sub>A</sub> = 25°C            | 4.5 V           | 4.4  | 4.5 |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +85°C  |                 | 4.4  |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +125°C |                 | 4.4  |     |     |      |
|                                           | I <sub>OH</sub> = −4 mA  | T <sub>A</sub> = 25°C            | 3 V             | 2.58 |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +85°C  |                 | 2.48 |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +125°C |                 | 2.48 |     |     |      |
|                                           | I <sub>OH</sub> = −8 mA  | T <sub>A</sub> = 25°C            | 4.5 V           | 3.94 |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +85°C  |                 | 3.8  |     |     |      |
|                                           |                          | T <sub>A</sub> = −40°C to +125°C |                 | 3.8  |     |     |      |

## 5.5 Electrical Characteristics (续)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER <sup>(1)</sup>                 | TEST CONDITIONS                                             |                                  | V <sub>CC</sub> | MIN | TYP | MAX  | UNIT |
|------------------------------------------|-------------------------------------------------------------|----------------------------------|-----------------|-----|-----|------|------|
| V <sub>OL</sub> Low level output voltage | I <sub>OL</sub> = 50 μA                                     | T <sub>A</sub> = 25°C            | 2 V             |     |     | 0.1  | V    |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = 25°C            | 3 V             |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = 25°C            | 4.5 V           |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 0.1  |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 0.1  |      |
|                                          | I <sub>OL</sub> = 4 mA                                      | T <sub>A</sub> = 25°C            | 3 V             |     |     | 0.36 |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 0.44 |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 0.44 |      |
|                                          | I <sub>OL</sub> = 8 mA                                      | T <sub>A</sub> = 25°C            | 4.5 V           |     |     | 0.36 |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 0.44 |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 0.44 |      |
| I <sub>I</sub> Input leakage current     | V <sub>I</sub> = 5.5 V or GND                               | T <sub>A</sub> = 25°C            | 0 V to 5.5 V    |     |     | ±0.1 | μA   |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | ±1   |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | ±1   |      |
| I <sub>CC</sub> Supply current           | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | T <sub>A</sub> = 25°C            | 5.5 V           |     |     | 1    | μA   |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 10   |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 10   |      |
| C <sub>i</sub> Input Capacitance         | V <sub>I</sub> = V <sub>CC</sub> or GND                     | T <sub>A</sub> = 25°C            | 5 V             |     | 2   | 10   | pF   |
|                                          |                                                             | T <sub>A</sub> = –40°C to +85°C  |                 |     |     | 10   |      |
|                                          |                                                             | T <sub>A</sub> = –40°C to +125°C |                 |     |     | 10   |      |

(1) Recommended T<sub>A</sub> = –40°C to +125°C

## 5.6 Switching Characteristics: V<sub>CC</sub> = 3.3 V ± 0.3 V

over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | OUTPUT<br>CAPACITANCE  | T <sub>A</sub> <sup>(1)</sup> | MIN | TYP | MAX  | UNIT |
|------------------|-----------------|----------------|------------------------|-------------------------------|-----|-----|------|------|
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 15 pF | 25°C                          |     | 5.5 | 7.9  | ns   |
|                  |                 |                |                        | −40°C to +85°C                | 1   |     | 9.5  |      |
|                  |                 |                |                        | −40°C to +125°C               | 1   |     | 10.5 |      |
| t <sub>PHL</sub> |                 |                |                        | 25°C                          |     | 5.5 | 7.9  |      |
|                  |                 |                |                        | −40°C to +85°C                | 1   |     | 9.5  |      |
|                  |                 |                |                        | −40°C to +125°C               | 1   |     | 10.5 |      |
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 50 pF | 25°C                          |     | 8   | 11.4 | ns   |
|                  |                 |                |                        | −40°C to +85°C                | 1   |     | 13   |      |
|                  |                 |                |                        | −40°C to +125°C               | 1   |     | 14   |      |
| t <sub>PHL</sub> |                 |                |                        | 25°C                          |     | 8   | 11.4 |      |
|                  |                 |                |                        | −40°C to +85°C                | 1   |     | 13   |      |
|                  |                 |                |                        | −40°C to +125°C               | 1   |     | 14   |      |

(1) Recommended T<sub>A</sub> = –40°C to +125°C

## 5.7 Switching Characteristics: $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$

over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | OUTPUT<br>CAPACITANCE  | T <sub>A</sub> <sup>(1)</sup> | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|------------------------|-------------------------------|-----|-----|-----|------|
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 15 pF | 25°C                          |     | 3.7 | 5.5 | ns   |
|                  |                 |                |                        | −40°C to +85°C                | 1   |     | 6.5 |      |
|                  |                 |                |                        | −40°C to +125°C               | 1   |     | 7   |      |
| t <sub>PHL</sub> |                 |                |                        | 25°C                          |     | 3.7 | 5.5 |      |
| −40°C to +85°C   |                 |                |                        | 1                             |     | 6.5 |     |      |
| −40°C to +125°C  |                 |                |                        | 1                             |     | 7   |     |      |
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 50 pF | 25°C                          |     | 5.2 | 7.5 | ns   |
|                  |                 |                |                        | −40°C to +85°C                | 1   |     | 6.5 |      |
|                  |                 |                |                        | −40°C to +125°C               | 1   |     | 9   |      |
| t <sub>PHL</sub> |                 |                |                        | 25°C                          |     | 5.2 | 7.5 |      |
| −40°C to +85°C   |                 |                |                        | 1                             |     | 6.5 |     |      |
| −40°C to +125°C  |                 |                |                        | 1                             |     | 9   |     |      |

(1) Recommended  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$

## 5.8 Operating Characteristics

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER                              | TEST CONDITIONS             | MIN | TYP | MAX | UNIT |
|----------------------------------------|-----------------------------|-----|-----|-----|------|
| $C_{pd}$ Power dissipation capacitance | No load, $f = 1\text{ MHz}$ |     | 9.5 |     | pF   |

## 5.9 Typical Characteristics

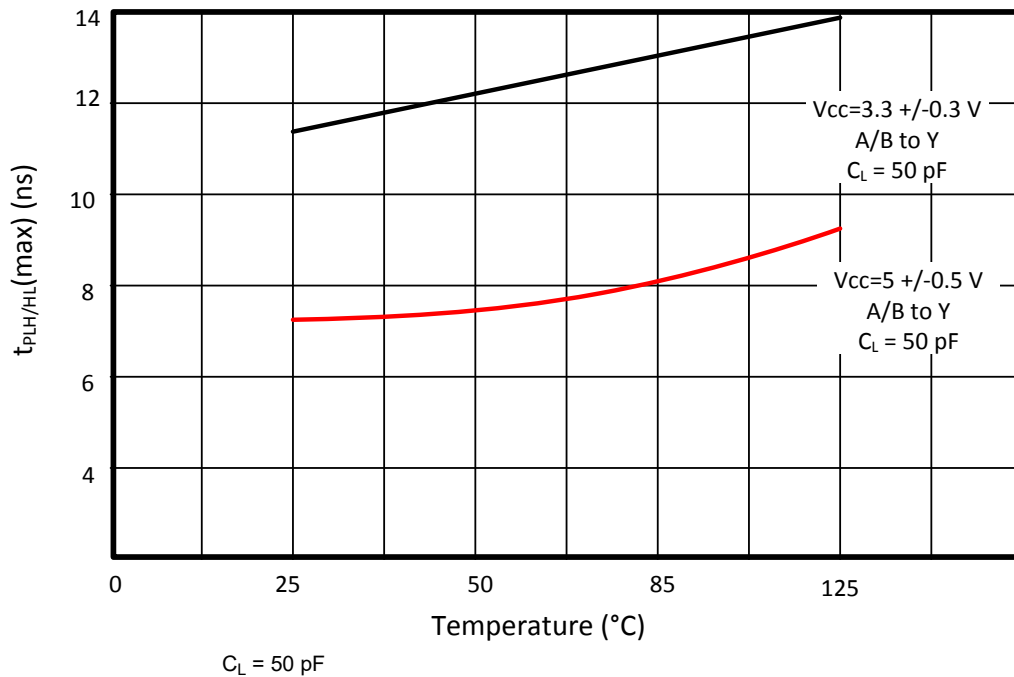
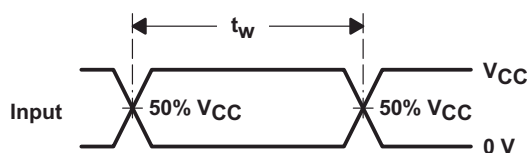
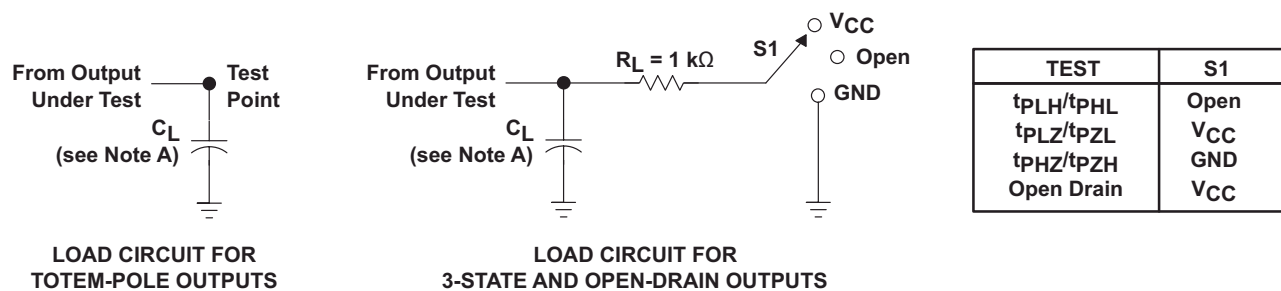
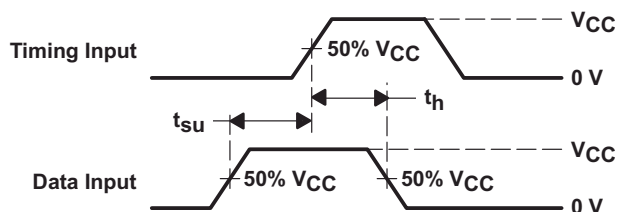


图 5-1. Propagation Delay vs Temperature

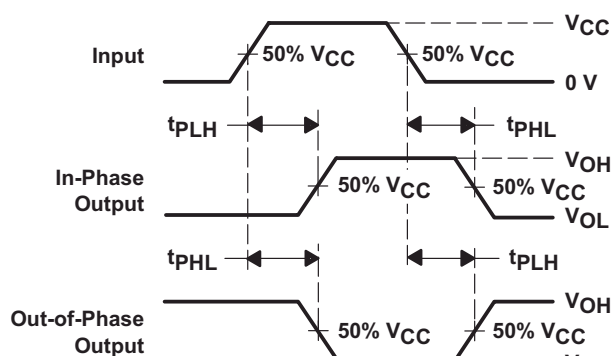
## 6 Parameter Measurement information



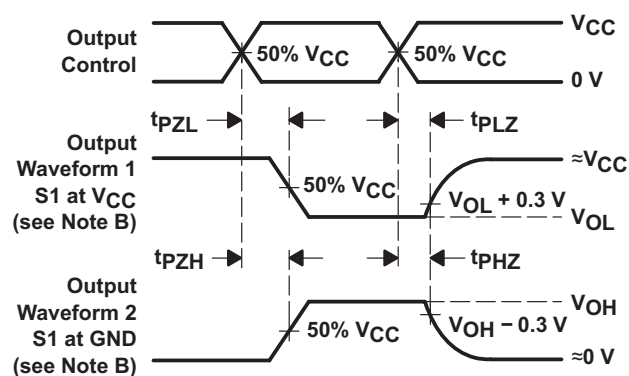
**VOLTAGE WAVEFORMS  
PULSE DURATION**



**VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS**



**VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING**

- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

**图 6-1. Load Circuit and Voltage Waveforms**

## 7 Detailed Description

### 7.1 Overview

The SN74AHC1G00 device performs the NAND Boolean function  $Y = \overline{A \times B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic. The device has a wide operating range of  $V_{CC}$  from 2 V to 5 V.

### 7.2 Functional Block Diagram



图 7-1. Logic Diagram (Positive Logic)

### 7.3 Feature Description

The SN74AHC1G00 device has wide operating voltage range for logic system from 2 V to 5 V. The low propagation delay allows fast switching and higher speeds of operation. In addition, the low power consumption of 10- $\mu$ A (maximum) makes this device a good choice for portable and battery power-sensitive applications. The Schmitt trigger action on all inputs have noise rejection capabilities.

### 7.4 Device Functional Modes

表 7-1. Function Table

| INPUTS <sup>(1)</sup> |   | OUTPUT <sup>(2)</sup> |
|-----------------------|---|-----------------------|
| A                     | B | Y                     |
| H                     | H | L                     |
| L                     | X | H                     |
| X                     | L | H                     |

(1) H = High Voltage Level, L = Low Voltage Level, X = Don't Care

(2) H = Driving High, L = Driving Low, Z = High Impedance State

## 8 Application and Implementation

### 备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

### 8.1 Typical Application

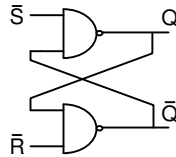


图 8-1. Typical Application

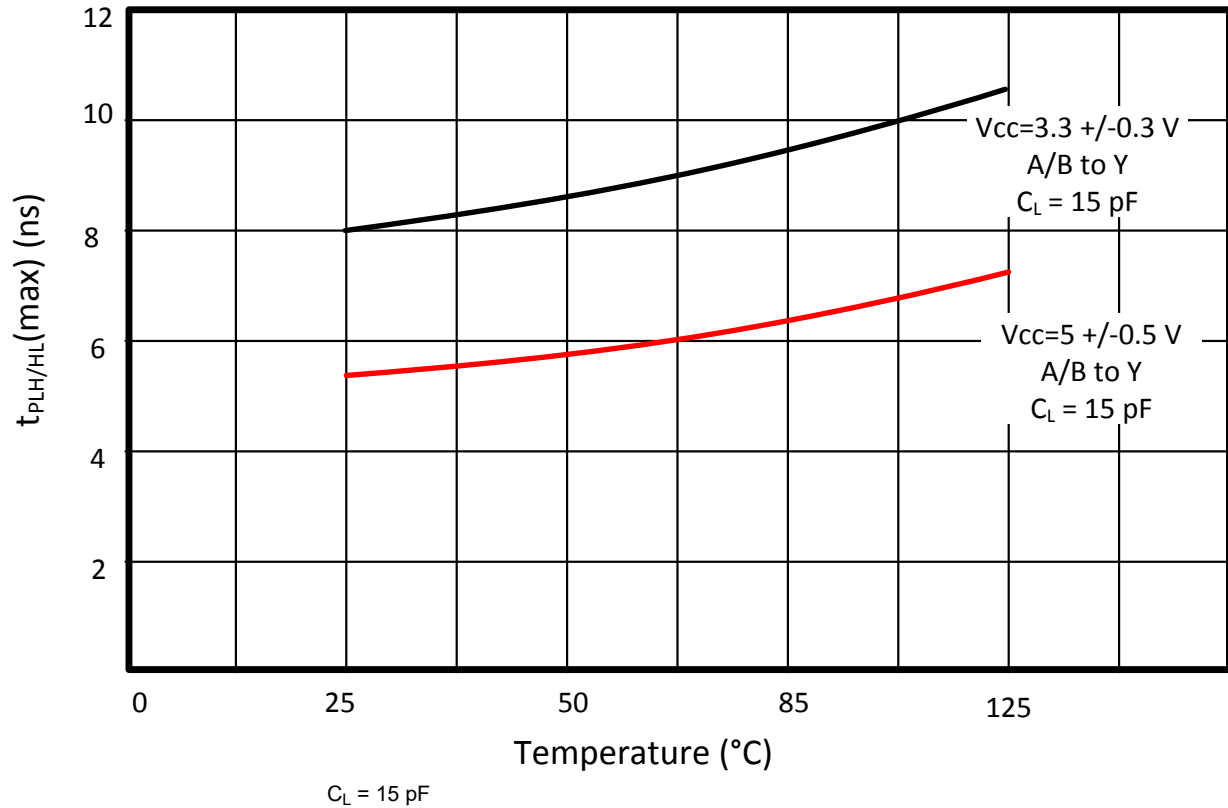
#### 8.1.1 Design Requirements

This SN74AHC1G00 device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive also creates fast edges into light loads. Routing and load conditions must be considered to prevent ringing.

#### 8.1.2 Detailed Design Procedure

- Recommended input conditions:
  - Specified high and low levels. See  $V_{IH}$  and  $V_{IL}$  in [§ 5.3](#).
  - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid  $V_{CC}$ .
- Recommended output conditions:
  - Load currents must not exceed 25 mA per output and 50 mA total for the part.
  - Outputs should not be pulled above  $V_{CC}$ .

### 8.1.3 Application Curve



**图 8-2. Propagation Delay vs Temperature**

### 8.2 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the [# 5.3](#).

Each  $V_{CC}$  terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, TI recommends a 0.1- $\mu$ F capacitor; if there are multiple  $V_{CC}$  terminals, then TI recommends a 0.01- $\mu$ F or 0.022- $\mu$ F capacitor for each power terminal. Multiple bypass capacitors can be paralleled to reject different frequencies of noise. Frequencies of 0.1  $\mu$ F and 1  $\mu$ F are commonly used in parallel. The bypass capacitor must be installed as close as possible to the power terminal for best results.

## 8.3 Layout

### 8.3.1 Layout Guidelines

When using multiple bit logic devices inputs must not ever float.

In many cases, functions or parts of functions of digital logic devices are unused. For example, when only two inputs of a triple-input AND gate are used or only three of the four buffer gates are used. Such input pins must not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. The following are the rules must be observed under all circumstances.

All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$  whichever make more sense or is more convenient. Floating outputs is generally acceptable, unless the part is a transceiver. If the transceiver has an output enable pin, it disables the outputs section of the part when asserted. This does not disable the input section of the input and output, so they also cannot float when disabled.

### 8.3.2 Layout Example

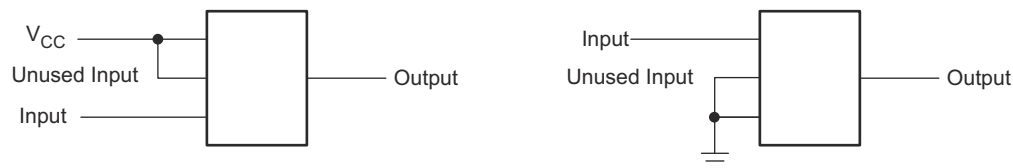


图 8-3. Layout Recommendation

## 9 Device and Documentation Support

### 9.1 Documentation Support

#### 9.1.1 Related Documentation

For related documentation, see the following:

- Texas Instruments, [Introduction to Logic application report](#)
- Texas Instruments, [Implications of Slow or Floating CMOS Inputs application note](#)

### 9.2 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](https://ti.com) 上的器件产品文件夹。点击 [通知](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

### 9.3 支持资源

**TI E2E™ 中文支持论坛** 是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [使用条款](#)。

### 9.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

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### 9.5 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 9.6 术语表

#### TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

## 10 Revision History

注：以前版本的页码可能与当前版本的页码不同

| Changes from Revision P (October 2023) to Revision Q (January 2024)                                                                                                                                    | Page |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Updated thermal values for DBV package from RθJA = 240 to 278, RθJC(top) = 174.5 to 180.5, RθJB = 73.7 to 184.4, ΨJT = 54.9 to 115.4, ΨJB = 60.1 to 183.4, RθJC(bot) = N/A, all values in °C/W ..... | 5    |

| Changes from Revision O (April 2016) to Revision P (October 2023)                                                                                                                                          | Page |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • 更新了整个文档中的表格、图和交叉参考的编号格式.....                                                                                                                                                                             | 1    |
| • Updated thermal values for DCK package from RθJA = 276.53 to 289.2, RθJC(top) = 118.5 to 205.8, RθJB = 62.8 to 176.2, ΨJT = 6.7 to 117.6, ΨJB = 62.1 to 175.1, RθJC(bot) = N/A, all values in °C/W ..... | 5    |

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)  | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)        | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|------------------|--------------------------------------|----------------------|--------------|--------------------------------|-------------------------|
| SN74AHC1G00DBVR   | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | RoHS & Green     | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | (A003, A00G, A00J, A00L, A00S) | <a href="#">Samples</a> |
| SN74AHC1G00DBVRG4 | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | A00G                           | <a href="#">Samples</a> |
| SN74AHC1G00DCK3   | ACTIVE        | SC70         | DCK                | 5    | 3000           | RoHS & Non-Green | SNBI                                 | Level-1-260C-UNLIM   | -40 to 125   | AAY                            | <a href="#">Samples</a> |
| SN74AHC1G00DCKR   | ACTIVE        | SC70         | DCK                | 5    | 3000           | RoHS & Green     | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | (1QP, AA3, AAG, AAJ, AAL, AAS) | <a href="#">Samples</a> |
| SN74AHC1G00DCKRE4 | ACTIVE        | SC70         | DCK                | 5    | 3000           | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AA3                            | <a href="#">Samples</a> |
| SN74AHC1G00DCKRG4 | ACTIVE        | SC70         | DCK                | 5    | 3000           | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AA3                            | <a href="#">Samples</a> |
| SN74AHC1G00DCKTG4 | ACTIVE        | SC70         | DCK                | 5    | 250            | RoHS & Green     | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AA3                            | <a href="#">Samples</a> |
| SN74AHC1G00DRLR   | ACTIVE        | SOT-5X3      | DRL                | 5    | 4000           | RoHS & Green     | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM   | -40 to 125   | (AAB, AAS)                     | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

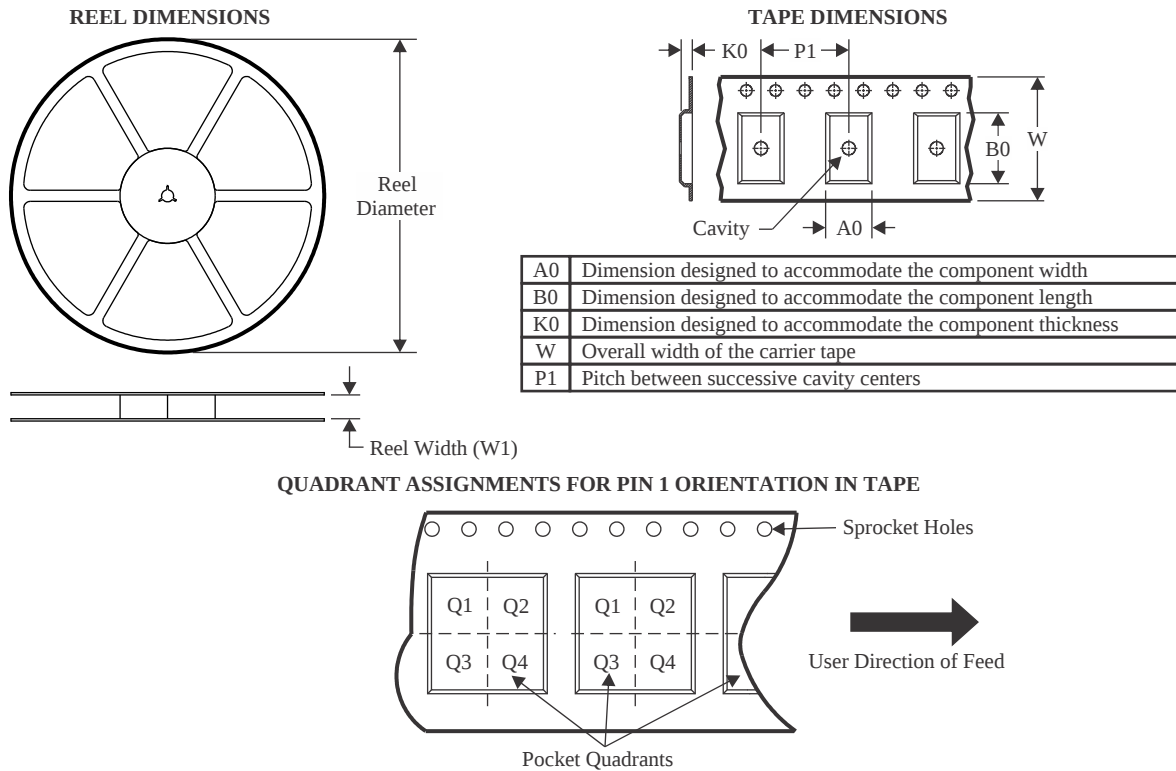
**OTHER QUALIFIED VERSIONS OF SN74AHC1G00 :**

- Automotive : [SN74AHC1G00-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AHC1G00DBVR   | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DBVR   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DBVRG4 | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DCKR   | SC70         | DCK             | 5    | 3000 | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DCKR   | SC70         | DCK             | 5    | 3000 | 178.0              | 9.0                | 2.4     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DCKRG4 | SC70         | DCK             | 5    | 3000 | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DCKTG4 | SC70         | DCK             | 5    | 250  | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AHC1G00DRLR   | SOT-5X3      | DRL             | 5    | 4000 | 180.0              | 8.4                | 1.98    | 1.78    | 0.69    | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHC1G00DBVR   | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AHC1G00DBVR   | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHC1G00DBVRG4 | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHC1G00DCKR   | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHC1G00DCKR   | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHC1G00DCKRG4 | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AHC1G00DCKTG4 | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AHC1G00DRLR   | SOT-5X3      | DRL             | 5    | 4000 | 202.0       | 201.0      | 28.0        |

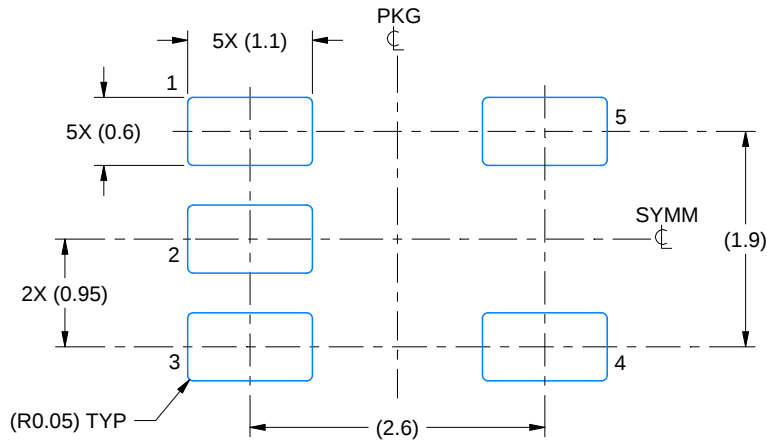


# EXAMPLE BOARD LAYOUT

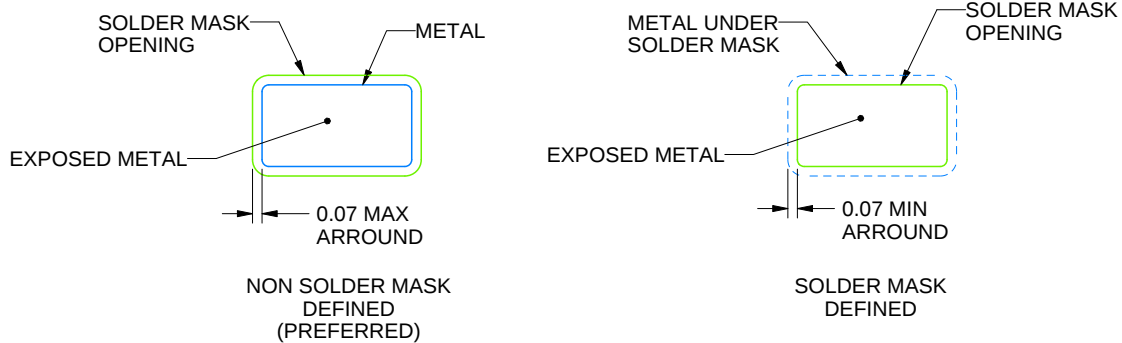
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/H 09/2023

NOTES: (continued)

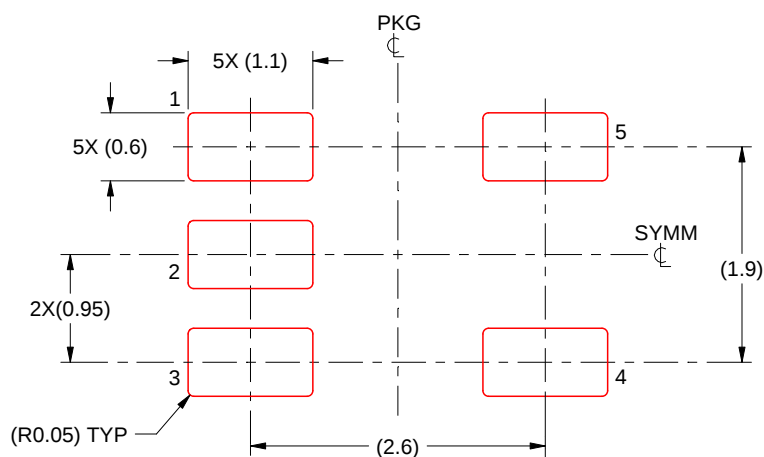
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

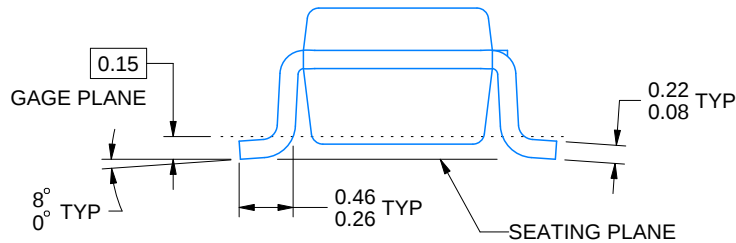
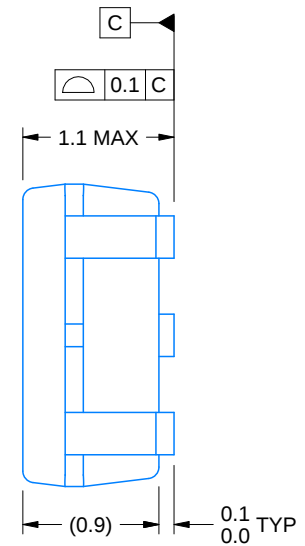
4214839/H 09/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



### SOT - 1.1 max height

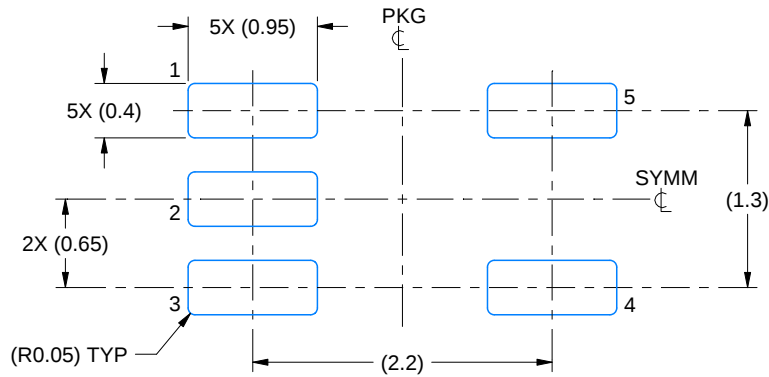
[illegible]

# EXAMPLE BOARD LAYOUT

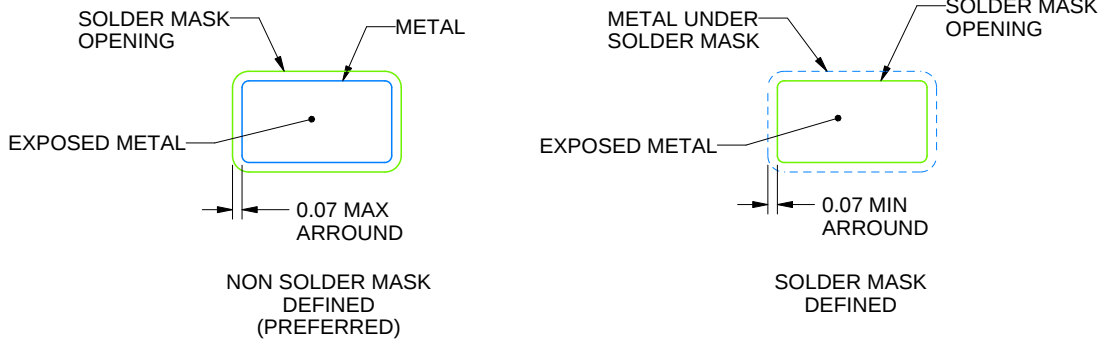
DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X

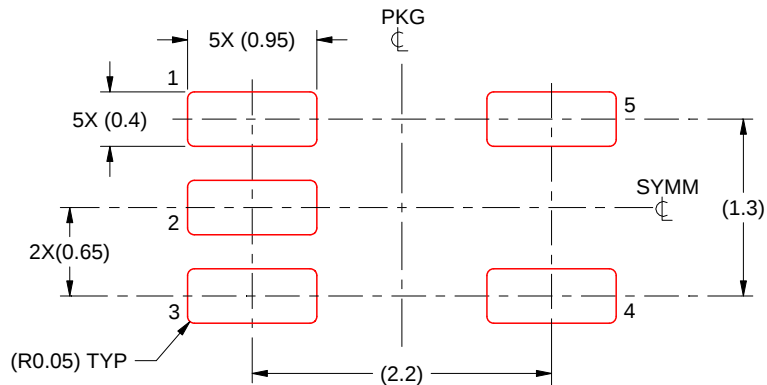


SOLDER MASK DETAILS

4214834/D 07/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
 BASED ON 0.125 THICK STENCIL  
 SCALE:18X

4214834/D 07/2023

NOTES: (continued)

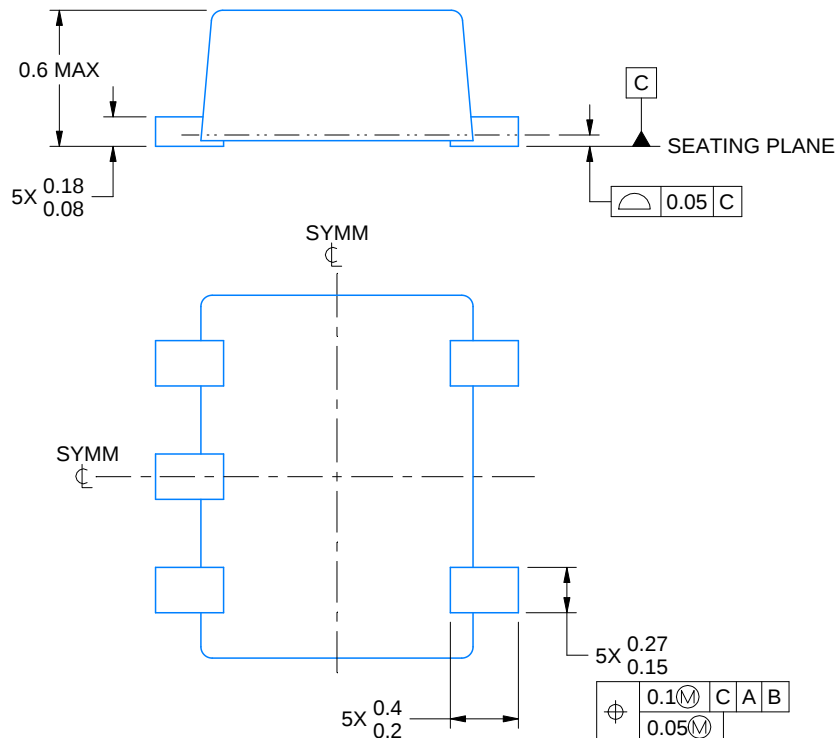
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



**SOT - 0.6 mm max height**

The drawing shows a rectangular component with the following dimensions and features:

- Overall Dimensions:**
  - Width: 1.7 (top) and 1.5 (middle)
  - Height: 1.7 (right) and 1.5 (middle)
- Pin 1 ID Area:** A shaded rectangular area on the left side, with a label "PIN 1 ID AREA" pointing to it.
- Pin Dimensions:**
  - Pin 1: 0.5 (width) and 1 (height)
  - Pin 2: 0.5 (width) and 1 (height)
  - Pin 3: 0.5 (width) and 1 (height)
  - Pin 4: 0.5 (width) and 1 (height)
  - Pin 5: 0.5 (width) and 1 (height)
- Other Dimensions:**
  - Distance from left edge to Pin 1: 1.3
  - Distance from Pin 1 to Pin 2: 1.1
  - Distance from Pin 2 to Pin 3: 1.1
  - Distance from Pin 3 to Pin 4: 1.1
  - Distance from Pin 4 to Pin 5: 1.1
  - Distance from Pin 5 to right edge: 1.1
  - Distance from left edge to Pin 1: 1.3
  - Distance from Pin 1 to Pin 2: 1.1
  - Distance from Pin 2 to Pin 3: 1.1
  - Distance from Pin 3 to Pin 4: 1.1
  - Distance from Pin 4 to Pin 5: 1.1
  - Distance from Pin 5 to right edge: 1.1
- Notes:**
  - NOTE 3: 1.7, 1.5
- Side View:** A side view of the component showing a rounded top and a flat bottom. The width is 0.05 TYP and the height is 0.00.



NOTES:

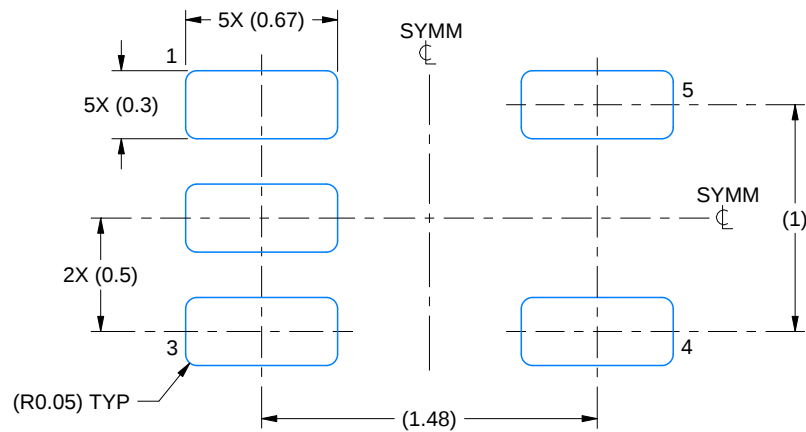
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-293 Variation UAAD-1

# EXAMPLE BOARD LAYOUT

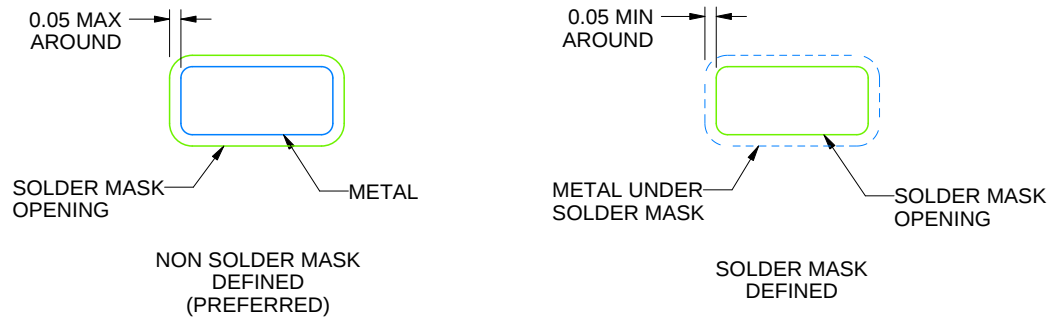
DRL0005A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



LAND PATTERN EXAMPLE  
SCALE:30X



SOLDERMASK DETAILS

4220753/B 12/2020

NOTES: (continued)

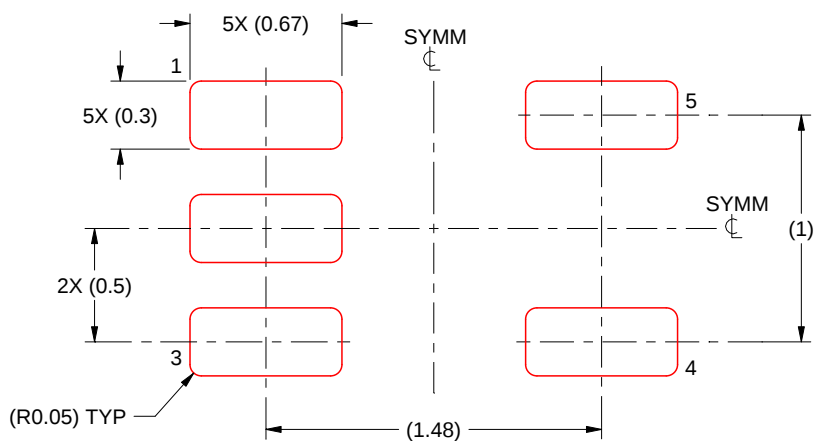
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DRL0005A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:30X

4220753/B 12/2020

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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